IN THE CLAIMS

1. (Currently Amended) A high frequency dielectric ceramics composition constituted by combining $(Zn_{1-x}M_x)TiO_3$ and $yTiO_2$ satisfies the conditions of:

M is Mg, Co or Ni, 'x' is $[0 \le x \le 0.6]$ $0 < x \le 0.6$ in case of Mg and 'x' is $[0 \le x \le 1]$ $0 < x \le 1$ in case of Co, and $[0 \le x \le 1]$ $0 < x \le 1$ in case of Ni, and $[0 \le y \le 0.8]$ $0 < y \le 0.8$.

2. (Original) A high frequency dielectric ceramics composition preparation method in which material powder of ZnO, MO (in this respect, MO is MgO, CoO or NiO) and TiO₂ is weighed according to a composition range of $(Zn_{1-x}M_x)TiO_3$ and $yTiO_2$ (M is one of Mg, Co and Ni, x is $0 \le x \le 0.6$ in case of Mg, x is $0 \le x \le 1$ in case of Co, x is $0 \le x \le 1$ in case of Ni, and y is $0 \le y \le 0.8$), mixed and dried,

calcined at a temperature of 850~950°C,

the calcined powder is crushed,

the crushed power is shaped,

the shaped body is fired at a temperature of 925~1100°C, and

 $(Zn_{1-x}M_x)TiO_3$ is calcined at a temperature corresponding to a region (region II) of below a phase dissociation temperature as shown in Figure 2 to obtain $(Zn_{1-x}M_x)TiO_3$ (M is Mg, Co or Ni) of a single phase of rhombohedral/hexagonal crystal.

3. (Original) The method of claim 2, wherein the shaped body is made in a manner that an aqueous solution adding a PVA binder is sprayed onto the crushed powder to make a granule, to which a pressure is applied.

- 4. (Original) The method of claim 3, further comprises a step for maintaining the shaped body at a temperature of 300~500°C for a predetermined time and removing the binder.
- 5. (Original) The method of claim 2, wherein $(Zn_{1-x}M_x)TiO_3$ is first calcined and $yTiO_2$ (0 $\le y\le 0.8$) is added to $(Zn_{1-x}M_x)TiO_3$ and then sintered.
- 6. (Original) The method of claim 2, wherein $(Zn_{1-x}M_x)TiO_3$ and $yTiO_2$ are sintered at the same time and sintered.
 - 7. (Original) The method of claim 2, wherein TiO2 is anatase or rutile.
 - 8. (Original) A high frequency dielectric ceramics composition constituted from combination of $(Zn_{1-a}Mg_{1-b}Co_{1-c}Ni_{1-d})TiO_3$ and $yTiO_2$ ($0 \le a \le 1$, $0 \le b \le 1$, $0 \le c \le 1$, $0 \le d \le 1$), and $0 \le y \le 0.8$.
- 9. (Currently Amended) Various high frequency devices such as a stacked chip capacitor, a stacked chip filter, a stacked chip capacitor/inductor composite device and a module, a low temperature sintered substrate, a resonator and a filter or a ceramic antenna, are fabricated by using the dielectric High frequency devices comprising the composition of claim 1.

10. (New) The high frequency devices of claim 9, wherein the high frequency devices are selected from the group consisting of a stacked chip capacitor, a stacked chip filter, a stacked chip capacitor/inductor composite device and a module, a low-temperature sintered substrate, a resonator, a filter, a ceramic antenna and combinations thereof.